**AEC-Q101 Qualified** 

# 4V Drive Pch MOSFET RSL020P03FRA

#### Structure

Silicon P-channel MOSFET

#### ● Features

- 1) Low On-resistance.
- 2) High speed switching.

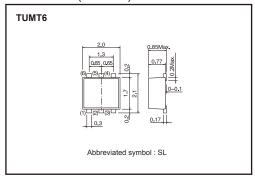
#### Applications

Switching

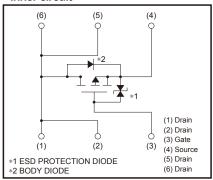
#### Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
RSL020P03I	0	

#### ●Dimensions (Unit:mm)



#### •Inner circuit



### ● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage		V <sub>DSS</sub>	-30	V
Gate-source voltage		V <sub>GSS</sub>	±20	V
Drain current	Continuous	$I_D$	±2	Α
Diairi current	Pulsed	I <sub>DP</sub> *1	±8	Α
Source current	Continuous	Is	-0.8	Α
(Body diode) Puls		I <sub>SP</sub> *1	-8	Α
Total power dissipation		P <sub>D</sub> *2	1	W
Channel temperature		Tch	150	°C
Range of storage temperature	Tstg	-55 to +150	°C	

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 Mounted on a ceramic board

#### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	125	°C/W

<sup>\*</sup> Mounted on a ceramic board

## ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	-	±10	μА	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V(BR) DSS	-30	_	_	V	I <sub>D</sub> = -1mA, V <sub>G</sub> s=0V
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	-1	μА	V <sub>DS</sub> = -30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-1.0	-	-2.5	V	V <sub>DS</sub> = -10V, I <sub>D</sub> = -1mA
Otatia daria an ana anatata		_	80	120	mΩ	I <sub>D</sub> = -2A, V <sub>GS</sub> = -10V
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	_	125	190	mΩ	I <sub>D</sub> =-1A, V <sub>GS</sub> = -4.5V
resistance		_	140	210	mΩ	I <sub>D</sub> = -1A, V <sub>GS</sub> = -4.0V
Forward transfer admittance	Y <sub>fs</sub> *	1.4	-	_	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -1A
Input capacitance	Ciss	_	350	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	-	80	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	_	50	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	_	11	_	ns	V <sub>DD</sub> ≒ −15V
Rise time	tr *	_	11	_	ns	ID= -1A   V 10V
Turn-off delay time	td (off) *	_	35	_	ns	V <sub>GS</sub> = -10V R <sub>I</sub> =15Ω
Fall time	t <sub>f</sub> *	_	11	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg	_	3.9	-	nC	V <sub>DD</sub> ≒-15V V <sub>GS</sub> =-5V
Gate-source charge	Qgs	_	1.3	-	nC	ID=-2A
Gate-drain charge	Q <sub>gd</sub>	ı	1.1	_	nC	RL= $7.5\Omega$ R <sub>G</sub> = $10\Omega$

<sup>\*</sup>Pulsed

## ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VsD	_	_	-1.2	V	I <sub>S</sub> = -0.8A, V <sub>GS</sub> =0V

#### •Electrical characteristics curves

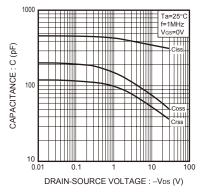


Fig.1 Typical Capacitance vs. Drain-Source Voltage

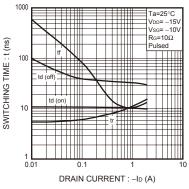


Fig.2 Switching Characteristics

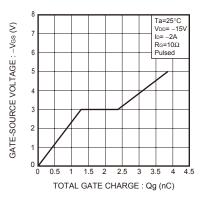


Fig.3 Dynamic Input Characteristics

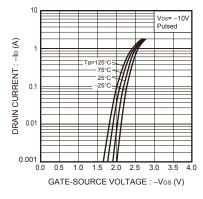


Fig.4 Typical Transfer Characteristics

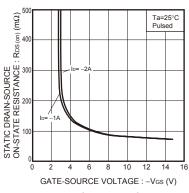


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

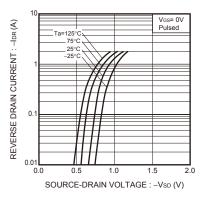


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

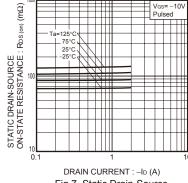


Fig.7 Static Drain-Source On-State Resistance vs. Drain current ( I )

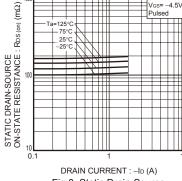


Fig.8 Static Drain-Source On-State Resistance vs. Drain current ( II )

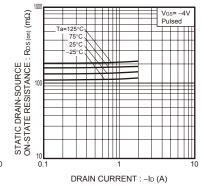


Fig.9 Static Drain-Source On-State Resistance vs. Drain current ( III )

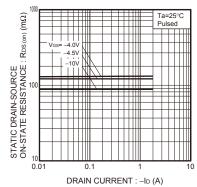


Fig.10 Static Drain-Source On-State Resistance vs. Drain current ( IV )

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JAPAN	N USA EU		CHINA
CLASSⅢ	CLACCIII	CLASS II b	СГУССШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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# RSL020P03FRA - Web Page

**Distribution Inventory** 

Part Number	RSL020P03FRA
Package	TUMT6
Unit Quantity	3000
Minimum Package Quantity	3000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes